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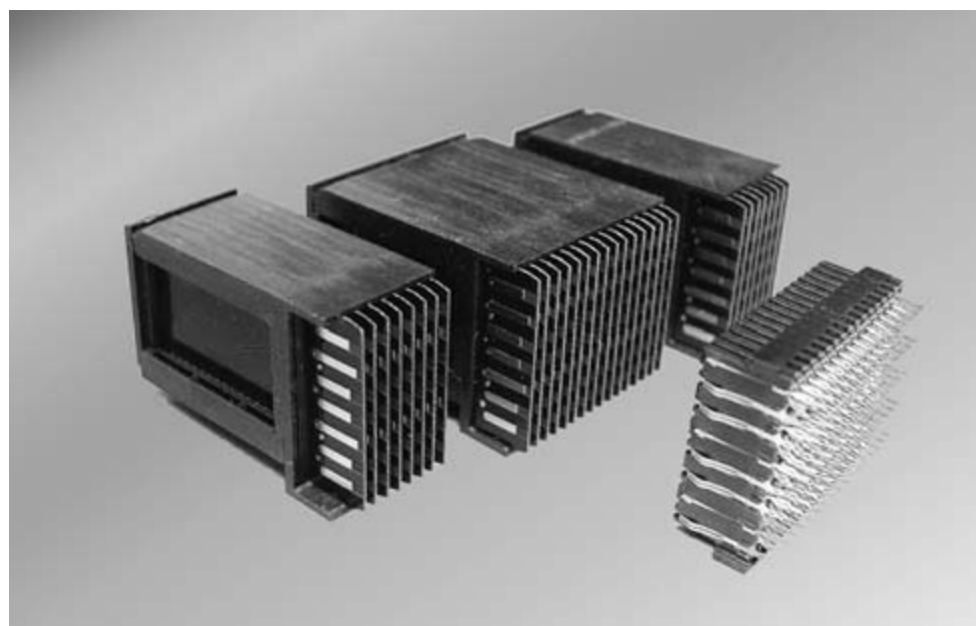
MULTIGIG RT Connector

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MULTIGIG RT Connector Products

Product Facts

- Customizable impedance matched printed circuit wafer interface
- Inverse sex backplane connector system with "pinless" interface
- Superior crosstalk performance
- Optimized footprints for signal integrity and ease of board design
- Utilizes a 0.56 [.022] diameter via for lower cost board fabrication
- Three levels of signal contact sequencing
- Available in modular or monoblock style
- Available for 20.30 [.800] or 25.40 [1.00] card pitch systems
- Durability rated for 200 cycles
- Fully compatible with MP based fiber optic array interconnects
- Complete connector family includes
 - Power Modules = > Maximize Amps/inch density, voltages in pairs
 - Guidance Modules
 - Die cast for strength
 - Optional ESD contact
 - Three sequence levels
 - Press fit or hardware mounted
 - Backplane drill pattern enabled keying
 - Cable assemblies proposals available
- MULTIGIG RT connector products are fully compatible with 2mm HM equipment practices



The MULTIGIG RT product line is a backplane interconnect family that offers levels of flexibility and customization never before seen in the industry. This printed circuit based, pinless, interconnect family is comprised of modular components which can be used in a variety of combinations. The connectors in this innovatively flexible platform can be combined to provide the density, data throughput, and signal integrity required for any application in today's computer, military, medical, or industrial control industries.

The use of printed circuit wafers in this connector system allows for cost effective sequencing and electrical customization of the connector. Wafers can be manufactured specifically for differential or signal ended performance and the impedance, propagation delay, and crosstalk of the connector can be altered per customer requirements. This scalable board to backplane connector family is a robust, "pinless" design which eliminates the pin field on backplane boards and reduces the end user's

exposure to field failure in card cage systems. The MULTIGIG RT connector family is designed specifically for 20.30 [.800] or 25.40 [1.00] card pitch systems.

- **MULTIGIG RT 1** — 141 signals/inch, data rates up to 3.125 Gb/s
- **MULTIGIG RT 2** — 113 signals/inch, data rates of 3.125 Gb/s to 6.4+ Gb/s and has been demonstrated to support 10 Gb/s
- **MULTIGIG RT 3** — 85 signals/inch, data rates above 10 Gb/s

Applications

- Telecommunications Equipment
 - Metro Optical Networking equipment
 - SONET switched platforms
 - Aggregation switches
- Midrange Servers
- High End Servers
- High speed custom platforms
- Mass data storage
- Rugged, mission-critical applications

Technical Documents

Application Specifications

114-13062 Power Modules
114-13056 Signal Connectors

Product Specifications

108-2062 Power Modules
108-2072 Signal Connectors

Qualification Test Reports

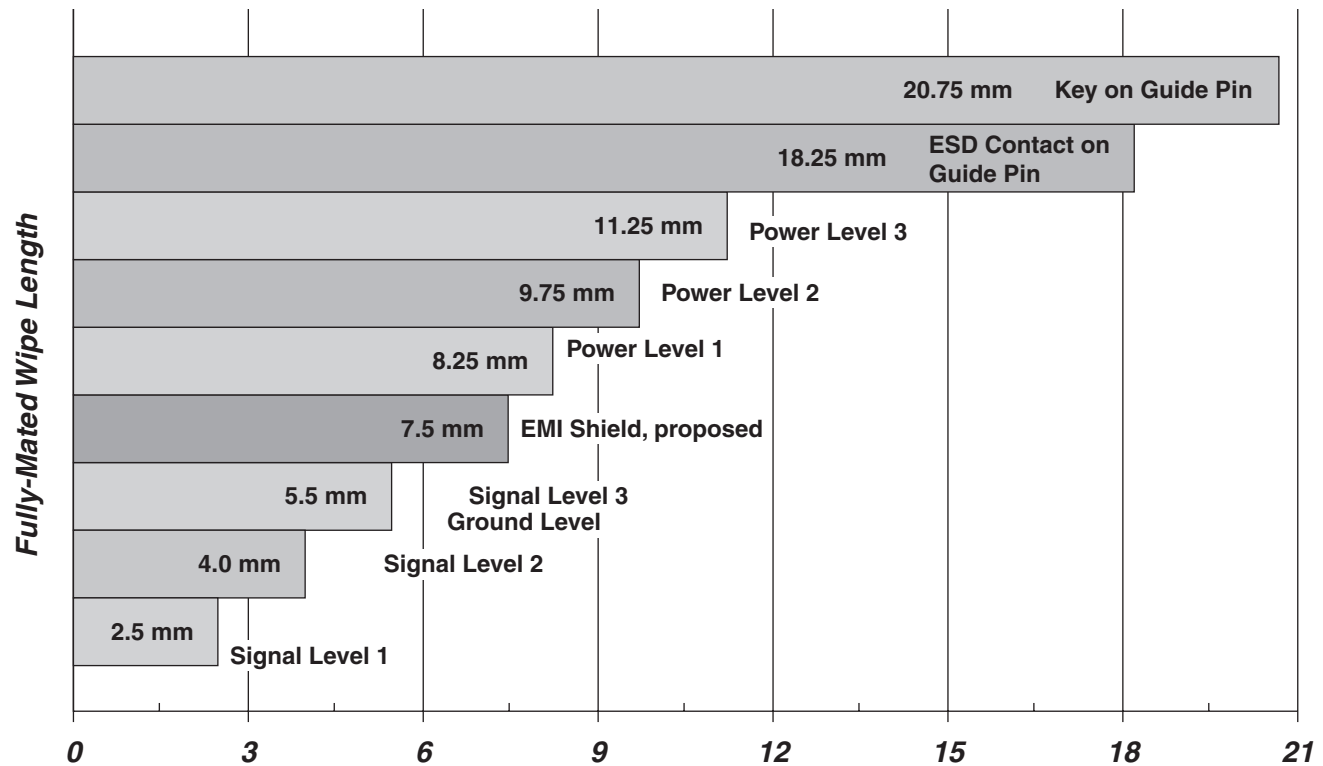
501-538 Power Connectors
501-544 Signal Connectors

Engineering Report

502-1130 Power Connectors
Routing Guide RT 2 on tycoelectronics.com

MULTIGIG RT Connector Products (Continued)

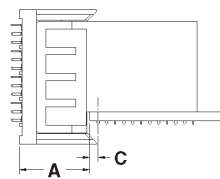
MULTIGIG RT Connector Sequencing Chart



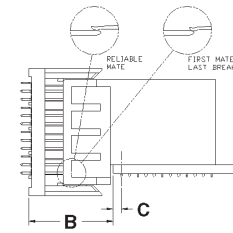
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MULTIGIG RT Connector

MULTIGIG RT Connector Mating Sequence Chart which shows the relationship of MULTIGIG RT Connector products with other Tyco Electronics products



Fully Mated



Reliable Mate

Product Family	Dim. C	Dim. A Fully Mated	Contact	Dim B.		Fully Mated Wipe Length
				Reliable Mate	First Mate Last Break	
HM-Zd	1.50 .059	12.50 .492	Ground Shield	16.78 [.661]	17.55 [.691]	4.28 [.169]
			Signal Level 2	15.41 [.607]	15.85 [.624]	2.91 [.115]
			Signal Level 1	13.91 [.548]	14.35 [.565]	1.41 [.056]
HM-Zd Guide Hardware	3.00 .118	12.50 .492	24.0 mm Pin	27.50 [1.083]	33.40 [1.315]	N/A
			22.2 mm Pin	25.70 [1.012]	31.60 [1.244]	N/A
			Key Blocking Point	N/A	22.03 [.867]	N/A
HM-2mm	1.50 .059	12.50 .492	Signal Level 3	18.27 [.719]	18.84 [.742]	5.77 [.227]
			Signal Level 2	16.77 [.660]	17.34 [.683]	4.27 [.168]
			Signal Level 1	15.27 [.601]	15.84 [.624]	2.77 [.109]
MULTIGIG RT T1	2.50 .098	12.50 .492	Ground	18.00 [.709]	—	5.50 [.217]
			Signal Level 3	18.00 [.709]	—	5.50 [.217]
			Signal Level 2	16.50 [.650]	—	4.00 [.157]
			Signal Level 1	15.00 [.591]	—	2.50 [.098]
MULTIGIG RT T2	2.25 .089	12.50 .492	Ground	18.00 [.709]	—	5.50 [.217]
			Signal Level 3	18.00 [.709]	—	5.50 [.217]
			Signal Level 2	16.50 [.650]	—	4.00 [.157]
			Signal Level 1	15.00 [.591]	—	2.50 [.098]
MULTIGIG RT T3	2.25 .089	12.50 .492	Ground	16.50 [.650]	—	4.00 [.157]
			Signal Level 1	15.00 [.591]	—	2.50 [.098]
MULTIGIG RT Power Module	5.50 .217	12.50 .492	Power Level 3	23.75 [.935]	—	11.25 [.443]
			Power Level 2	22.25 [.876]	—	9.75 [.384]
			Power Level 1	20.75 [.817]	—	8.25 [.325]
MULTIGIG RT Guide Hardware	N/A	12.50 .492	Guide Pin Key	33.25 [1.309]	N/A	20.75 [.817]
			Guide ESD Contact	30.75 [1.211]	—	18.25 [.719]
HS-3	1.50 .059	12.50 .492	Ground	17.08 [.672]	17.60 [.693]	4.78 [.188]
			Signal Level 2	16.05 [.632]	16.47 [.648]	3.75 [.148]
			Signal Level 1	14.55 [.573]	14.97 [.589]	2.25 [.089]
UPM	3.50 .138	12.50 .492	Power Level 3	20.25 [.797]	20.95 [.825]	8.10 [.319]
			Power Level 2	18.65 [.734]	19.35 [.762]	6.50 [.256]
			Power Level 1	17.03 [.670]	17.73 [.698]	4.88 [.192]
UPM Guide Hardware	5.75 .226	12.50 .492	Guide Pin Key	31.39 [1.236]	36.16 [1.424]	N/A
			Keyed Guide Pin	31.39 [1.236]	36.16 [1.424]	N/A
			Keyed Guide Pin	35.23 [1.387]	40.00 [1.575]	N/A
MULTI-BEAM XL Right Angle Header to Vertical Receptacle	5.08 .200	14.73 .580	PreMate Power — Level 1	—	16.84 [.663]	5.61 [.221] Min.
			PostMate Power — Level 2	—	17.81 [.701]	4.34 [.171] Min.
			PreMate Signal — Level 2	—	18.26 [.719]	3.81 [.150] Min.
			PostMate Signal — Level 3	—	19.53 [.769]	2.54 [.100] Min.
MULTI-BEAM XL Right Angle Receptacle to Vertical Header	3.81 .150	13.21 .520	PreMate Power — Level 1	—	15.32 [.603]	5.61 [.221] Min.
			PostMate Power — Level 2	—	16.28 [.641]	4.34 [.171] Min.
			PreMate Signal — Level 2	—	16.74 [.659]	3.81 [.150] Min.
			PostMate Signal — Level 3	—	18.01 [.709]	2.54 [.100] Min.

MULTIGIG RT Connector Products (Continued)

Product Selection Guide

MULTIGIG RT connectors consist of interlocking left end and right end signal modules (half or full), center signal modules, and stand alone modules available in vertical receptacles (backplane application) and right angle plugs (daughtercard application), and complementary mechanical guide assemblies (available in size 10.80 [.425] or 7.20 [.283]). The guide assembly provides blind mating and misalignment for the connectors. The 10.80 [.425] guide assembly also provides keying and is available with or without an internal contact for electrostatic discharge (ESD) protection.

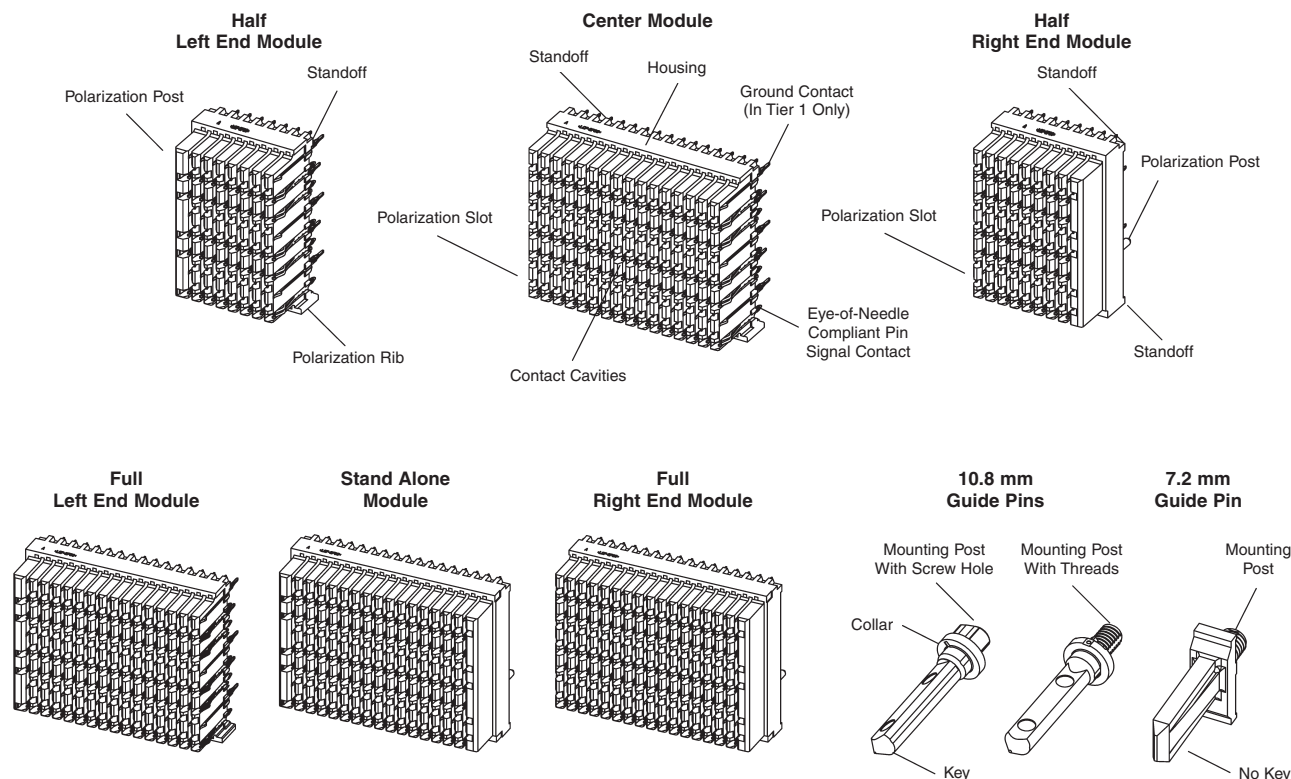
The modules are capable of being stacked in any configuration within the limitations given in this catalog to a maximum length of 120 between guide assemblies. These connectors perform at two separate density levels: Tier 1 and Tier 2. The connectors are placed on the pc board by manually-operated or automatic machines.

The modules have 6, 8, or 10 rows of signal contacts with 20.30 [.800], 25.40 [1.000], or 30.50 [1.201] centerline spacing (profile size). A right angle plug module having 7 rows with 20.30 [.800] spacing is also available for Tier 2 only to

accommodate special applications used by the VMEbus International Trade Association (VITA). The signal contacts, along with the ground contacts (in Tier 1 modules only) and ESD contacts (if using the 10.80 [.425] guide assembly with ESD contact) provide sequencing for each group of modules.

When corresponding with personnel, use the terminology provided to facilitate your inquiries for information. Basic terms and features of this product are provided in the art below and on the following page.

Vertical Receptacle (Backplane) Connector

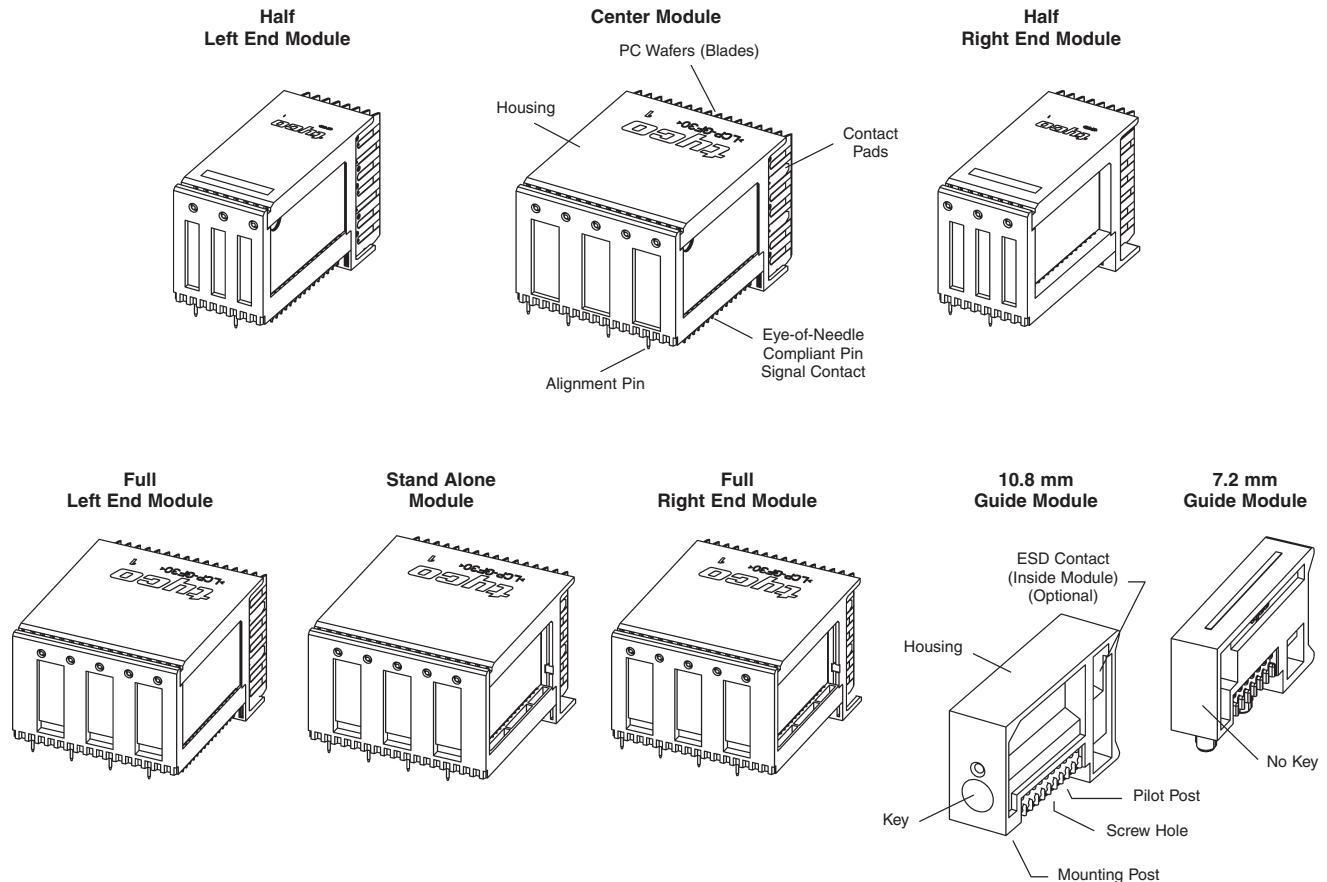


MULTIGIG RT Connector Products (Continued)

Product Selection Guide

(Continued)

**Right Angle Plug
(Daughtercard) Connector**



Signal Modules

Tier 1 and Tier 2 receptacles contain eye-of-needle compliant pin signal contacts; the Tier 1 receptacle also contains ground contacts. Each housing features standoffs for thermal venting, polarization ribs (on end modules) and polarization slots (on the center module) for proper stacking of the modules, and polarization posts to ensure correct orientation on the pc board.

Plugs contain eye-of-needle compliant pin signal contacts and pc wafers (blades). The housing features alignment pins to ensure correct orientation on the pc board.

Guide Assemblies

The guide assembly consists of a guide pin (used with receptacles) and a guide module (used with plugs).

The guide pin features a collar and mounting post

(having a screw hole or threads) with or without a key. The guide pins are available with various length mounting posts. The mounting post is used with customer supplied hardware to attach the guide pin to the pc board. Guide pins must be chosen according to thickness of pc board being used; otherwise, interference with proper mating or damage to system components will occur. Guide pins with keys are available in various keying positions.

The guide module features a housing with or without a key and with a screw hole, mounting post, and pilot post. The mounting post and pilot post are used to position the guide module on the pc board, and the screw hole is used with customer supplied hardware to attach the module to the pc board. The 10.80 [.425] guide module is available with or without an ESD contact located inside the module.

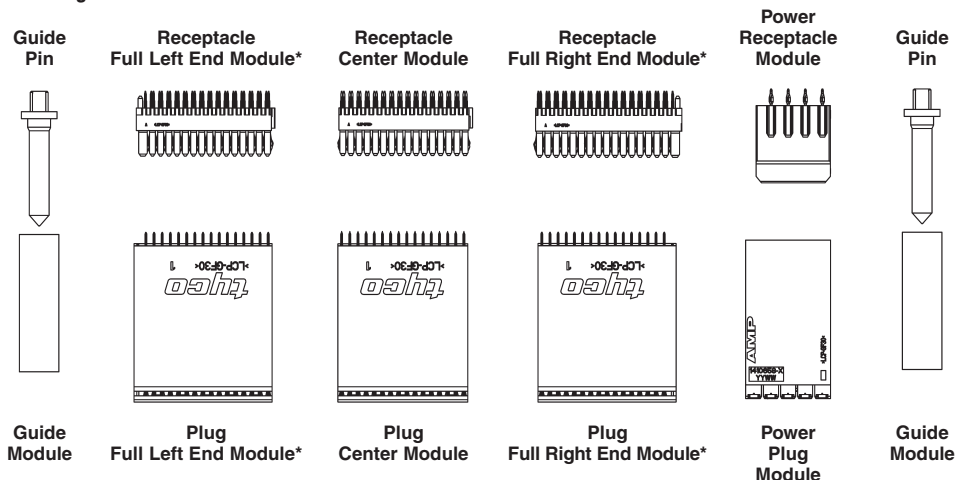
MULTIGIG RT Connector Products (Continued)

Product Selection Guide

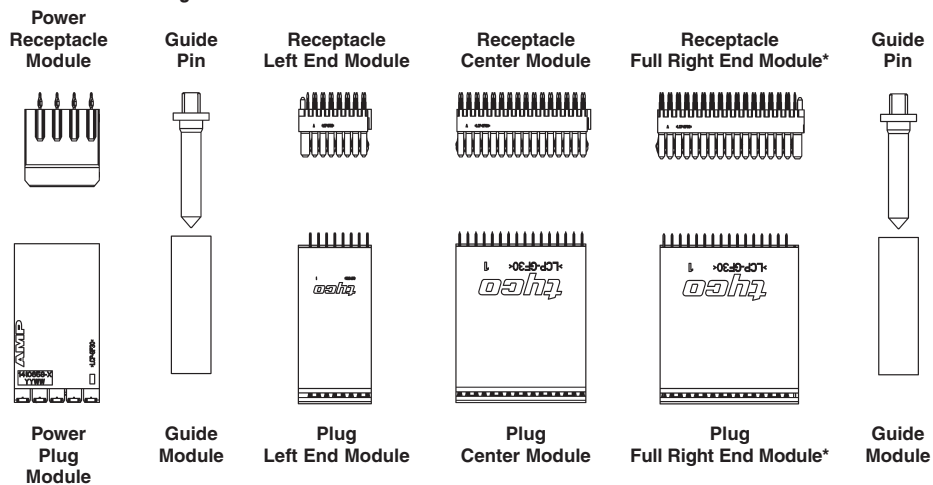
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Possible Module Configurations Used with Power Modules

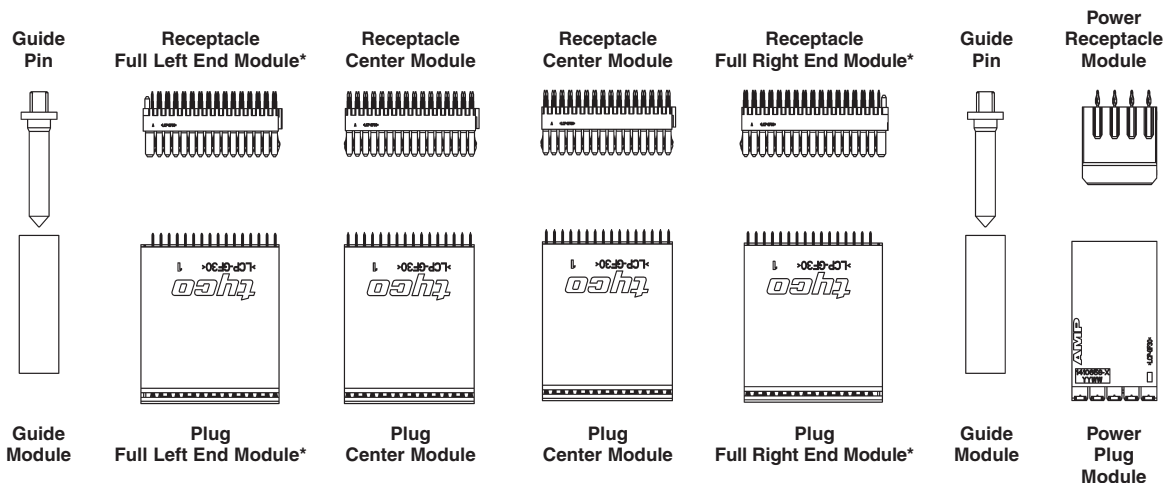
Three Signal Modules and One Power Module



Two and One-Half Signal Modules and One Power Module



Four Signal Modules with One Power Module



* A Half Left End Module and a Half Right End Module can be used instead.

Customization Options

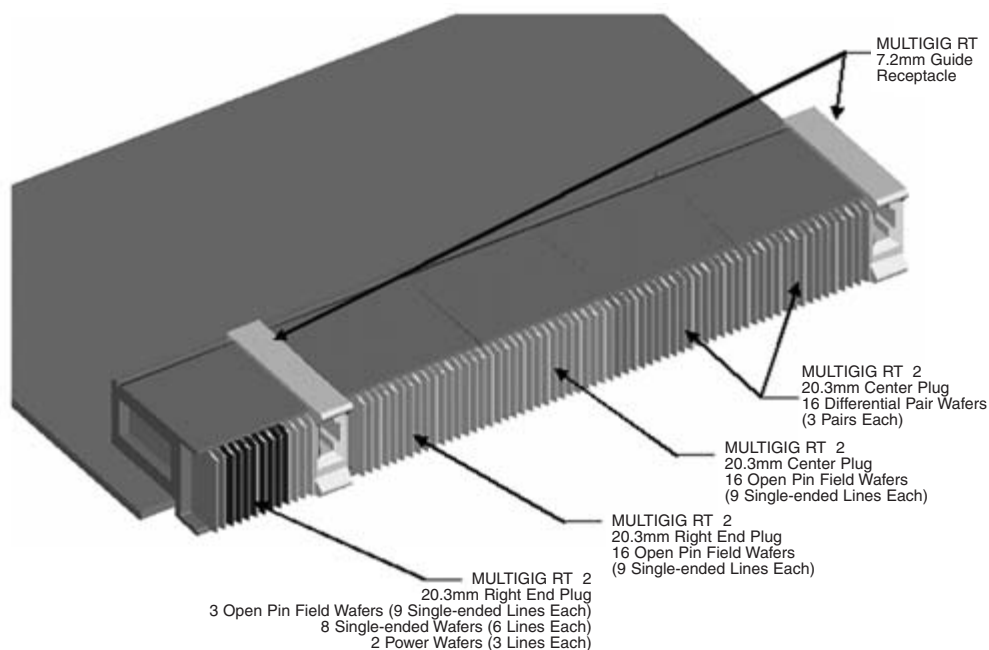
The MULTIGIG RT Product Line is fully customizable. This is accomplished by means of stacking the PCB wafers in the correct location to achieve the desired mix of High Speed Differential, High Speed Single-ended, and low

speed/high speed density signals. In addition, power can be carried through the PCB wafers by replacing one or more signal wafers for a power wafer.

Shown below is a Tyco Electronics proposal for a typical MULTIGIG RT

Connector application. As you can see, we took full advantage of the MULTIGIG RT Connector capabilities. Contact your Tyco Electronics representative to have a proposal drawn-up to meet your specific needs.

Typical MULTIGIG RT Connector Implementation



MULTIGIG RT Connector Products (Continued)

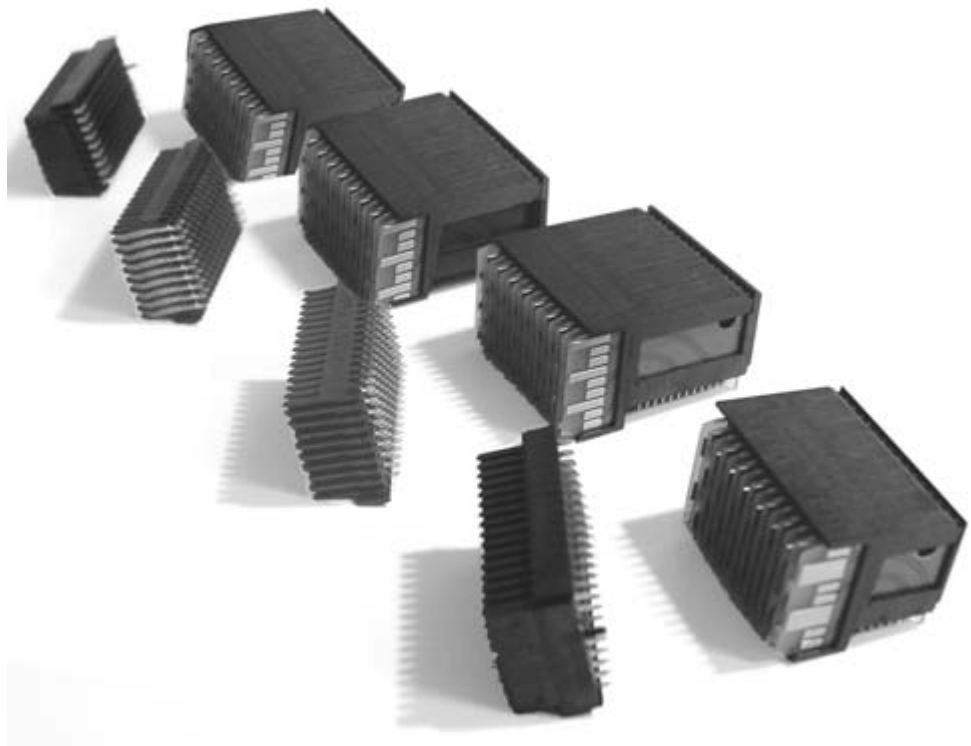
Customization Options

(Continued)

Tier 1 Options

The Tier 1 connector system can be customized with Differential and Single-ended wafers. In addition, a power wafer is available for the 25.40 [1.000] pitch

product that provides 4 power lines and 2 sense lines per wafer. Shown below are differential, single-ended and power options.



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MULTIGIG RT Connector

MULTIGIG RT Connector Products (Continued)

Customization Options

(Continued)

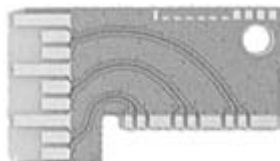
Tier 2 and Tier 3 Options

The Tier 2 and Tier 3 connector system is fully customizable due to the lack of a bussed ground system. This allows us to stack the many options available (with more being

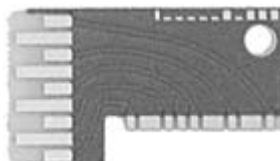
developed as needed) in any configuration that is necessary to meet the customers needs. Shown here are some of the options that are currently available.

**Signal Options Available:
0.8" Shown**

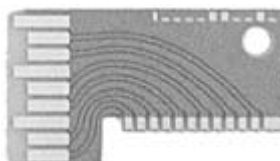
Differential Wafers



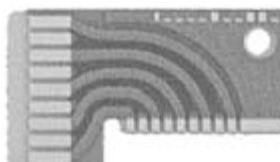
Single-ended w/ 1:1 S/G Ratio



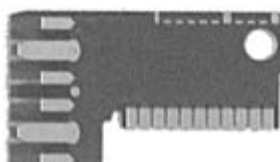
Single-ended w/ 2:1 S/G Ratio



**Open Pin Field
(No Reference Ground)**



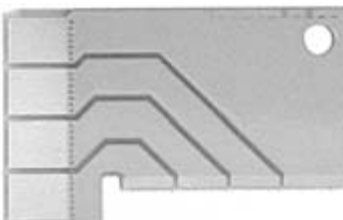
Mixed, Differential and S/E Lines



Custom, Vita 41, Mixed



**Up to 4 Power Lines/Wafer
Total of 19 AMPS/Wafer**



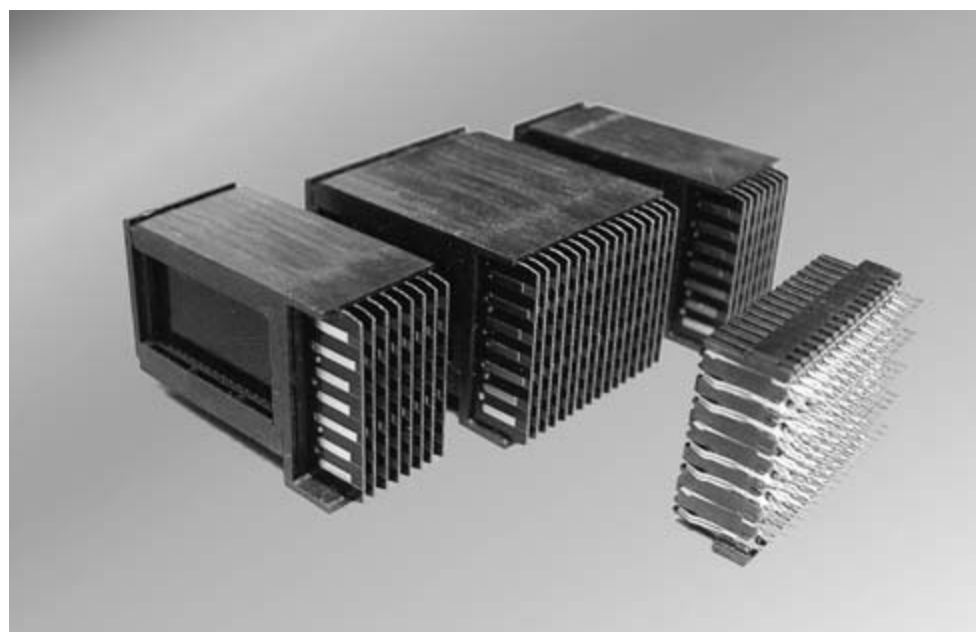
MULTIGIG RT Tier 1 Connector System

Target Applications

- High speed telecommunications equipment
- Midrange and high-end servers
- Networking equipment
- Blindmate design
- High speed custom platforms
- Mass data storage
- Rugged, mission-critical applications

Product Features

- Excellent performance to 3.125 Gb/s
- High density: 140 contacts per inch provides 70 contact pairs per inch for differential signaling
- Options include 20.32 [.800] and 25.40 [1.000] pitch card spacing
- Modular options for signal, power, keying and guidance
- Optimized footprints
- Robust design
- Low noise levels
- Supports differential pair widths of 6 mils with 9 mil spacings
- Single-ended option available; contact Tyco Electronics for performance data



The MULTIGIG RT Tier 1 connector meets customer requirements for high-density and high-performance two-piece interconnects. In Tyco Electronics and independent lab tests, the MULTIGIG RT Tier 1 connector has performed in excess of 3 Gb/s using standard FR-4 board material and routing techniques. The MULTIGIG RT Tier 1 connector is a differential connector with a contact density of 70 pairs per inch. The robust connector uses daughtercard plugs with a

printed circuit board (PCB) wafer design and backplane receptacles with a completely enclosed dual-beam design. All signal lines use redundant points of contact for high reliability.

The MULTIGIG RT Tier 1 connector is available for both 20.32 [.800] and 25.40 [1.000] pitch card spacing. The totally modular system allows flexibility in choosing signal and power modules as well as guidance, keying, and electrostatic discharge (ESD) modules to meet the most demanding

applications. Signal modules can be customized for specific electrical requirements—such as sequencing—that are critical in high speed applications.

Power modules are available with two- and four-voltage options, each circuit capable of carrying 15 amps. The robust metal guide pin provides eight keying options and a unique ESD contact to discharge static when daughtercards are hot-plugged.

Availability

Fully validated SPICE models: E-mail requests to modeling@tycoelectronics.com

Pro/E models and IGES models: E-mail requests to TycoCAD@tycoelectronics.com

www.tycoelectronics.com

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MULTIGIG RT Connector

MULTIGIG RT Tier 1 Connector System (Continued)

Mechanical Design Summary

Mechanical Features

- Extremely rugged connector for mission critical applications
- Three signal sequencing levels plus an additional three power sequencing levels
- Keyed guide modules standard: cannot mate connector incorrectly, and provide ± 3 mm of gage
- Options available include:
 - Power modules
 - Electrostatic discharge guide pins
 - Multiple guide pin keying options
- High signal density: 70 pairs for differential signals

20.30 [.800] Pitch Connector

Type	Style	No. of Cols.	Signal Pattern	Part Number
(Backplane) Receptacle	Center	16	N/A	1410200-1
	Stand Alone	16	N/A	1410420-1
	Half Left	8	N/A	1410226-1
	Half Right	8	N/A	1410227-1
	Full Left	16	N/A	1410201-1
	Full Right	16	N/A	1410202-1
(Daughtercard) Plug	Center	16	S.E.	1410205-1
	Center	16	Diff.	1410205-2
	Stand Alone	16	S.E.	1410421-1
	Stand Alone	16	Diff.	1410421-2
	Half Left	8	S.E.	1410228-1
	Half Left	8	Diff.	1410228-2
(Daughtercard) Plug	Half Right	8	S.E.	1410229-1
	Half Right	8	Diff.	1410229-2
	Full Left	16	S.E.	1410206-1
	Full Left	16	Diff.	1410206-2
	Full Right	16	S.E.	1410207-1
	Full Right	16	Diff.	1410207-2

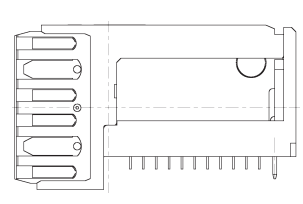
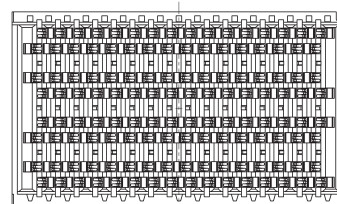
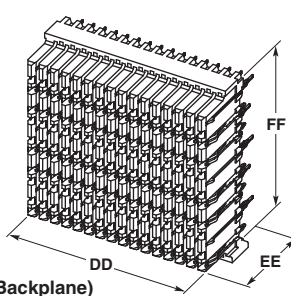
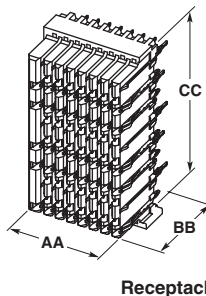
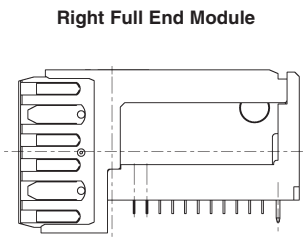
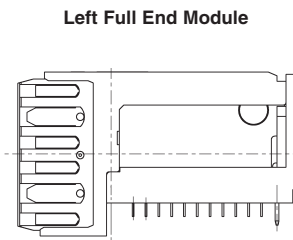
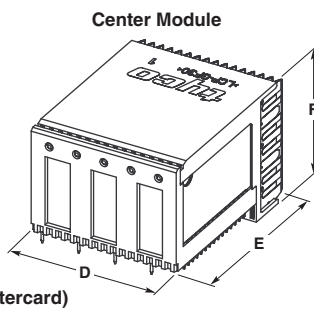
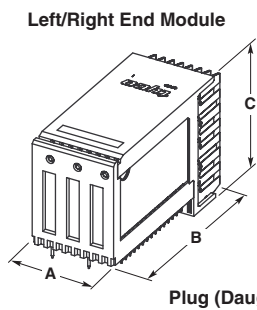
25.40 [1.00] Pitch Connector

Type	Style	No. of Cols.	Signal Pattern	Part Number
(Backplane) Receptacle	Center	16	N/A	1410210-1
	Stand Alone	16	N/A	1410412-1
	Half Left	8	N/A	1410231-1
	Half Right	8	N/A	1410230-1
	Full Left	16	N/A	1410211-1
	Full Right	16	N/A	1410212-1
(Daughtercard) Plug	Center	16	S.E.	1410215-1
	Center	16	Diff.	1410215-2
	Stand Alone	16	S.E.	1410413-1
	Stand Alone	16	Diff.	1410413-2
	Half Left	8	S.E.	1410232-1
	Half Left	8	Diff.	1410232-2
(Daughtercard) Plug	Half Right	8	S.E.	1410233-1
	Half Right	8	Diff.	1410233-2
	Full Left	16	S.E.	1410216-1
	Full Left	16	Diff.	1410216-2
	Full Right	16	S.E.	1410217-1
	Full Right	16	Diff.	1410217-2

The drawings below show the nominal dimensions for the MULTIGIG RT 1 connector modules

Dim.	20.32 [.800] Connector	25.40 [1.000] Connector
A	16.10 .630	16.10 .630
B	21.60 .850	27.40 1.080
C	18.40 .720	24.20 .950
D	28.70 1.130	28.70 1.130
E	21.60 .850	27.40 1.080
F	18.40 .720	24.20 .950

Dim.	20.32 [.800] Connector	25.40 [1.000] Connector
AA	R = 17.00 .067 L = 15.20 .600	R = 17.00 .067 L = 15.20 .600
BB	10.50 .410	10.50 .410
CC	18.60 .730	24.40 .960
DD	28.70 1.130	28.70 1.130
EE	10.50 .410	10.50 .410
FF	18.60 .730	24.40 .960



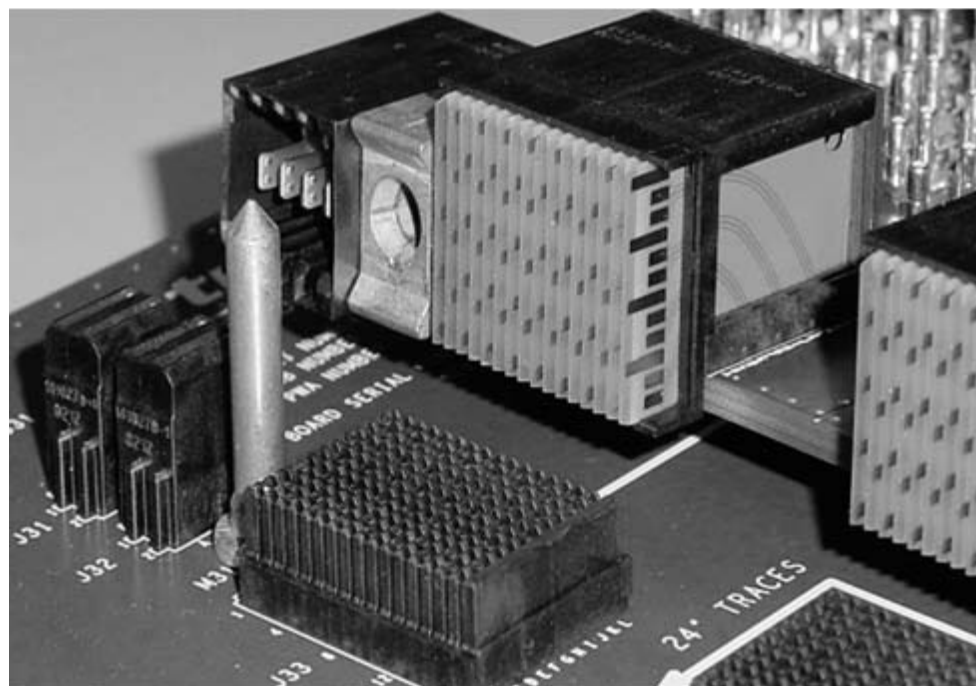
MULTIGIG RT Tier 2 Connector System

Target Applications

- High speed telecommunications equipment
- Midrange and high-end servers
- Networking equipment
- Blindmate design
- High speed custom platforms
- Mass data storage
- Rugged, mission-critical applications

Product Features

- Excellent performance to 6.25+ Gb/s—
- High density: 113 contacts per inch provides 56 contact pairs per inch for differential signaling
- Options include 20.32 [.800] and 25.40 [1.000] pitch card spacing
- Modular options for signal, power, keying and guidance
- Optimized footprints
- Robust design
- Low noise levels
- Supports differential pair widths of 6 mils with 9 mil spacings
- Single-ended, open pin field and power wafers available



The MULTIGIG RT Tier 2 connector is the latest product release to meet customer requirements for high-density and high-performance two-piece interconnects. In Tyco Electronics and independent lab tests, the MULTIGIG RT Tier 2 connector has performed in excess of 6 Gb/s using standard FR-4 board material and routing techniques, and has **been demonstrated to 10 Gb/s**.

The MULTIGIG RT Tier 2 connector system provides the flexibility to configure the daughtercard for Differential, Single-ended,

Open Pin Field, or Power within a single connector module. All of these options then mate into a common Backplane Receptacle. The robust connector uses daughtercard plugs with a printed circuit board (PCB) wafer design and backplane receptacles with a completely enclosed dual-beam design. All signal lines use redundant points of contact for high reliability.

The MULTIGIG RT Tier 2 connector is available for both 20.32 [.800] and 25.40 [1.000] pitch card spacing. The totally modular system allows flexibility in choosing signal and power modules

as well as guidance, keying, and electrostatic discharge (ESD) modules to meet the most demanding applications. Signal modules can be customized for specific electrical requirements—such as sequencing—that are critical in high speed applications.

Power modules are available with two- and four-voltage options, each circuit capable of carrying 15 amps. The robust metal guide pin provides eight keying options and a unique ESD contact to discharge static when daughtercards are hot-plugged.

Availability

Fully validated SPICE models: E-mail requests to modeling@tycoelectronics.com

Pro/E models and IGES models: E-mail requests to TycoCAD@tycoelectronics.com

www.tycoelectronics.com

**Mechanical Design
Summary**

MULTIGIG RT Tier 2 Connector System (Continued)

20.30 [.800] Pitch Connector

Type	Style	No. of Cols.	Signal Pattern	Part Number
(Backplane) Receptacle	Center	16	N/A	1410140-1
	Stand Alone	16	N/A	1410133-1
	Half Left	8	N/A	1410186-1
	Half Right	8	N/A	*
	Full Left	16	N/A	1410141-1
	Full Right	16	N/A	1410142-1
	Right End	18	N/A	1410456-1
(Daughtercard) Plug	Center	16	S.E.	*
		16	Diff.	1410137-1
	Stand Alone	16	S.E.	*
		16	Diff.	1410134-1
	Half Left	8	S.E.	*
		8	Diff.	*
	Half Right	8	S.E.	*
		8	Diff.	*
	Full Left	16	S.E.	*
		16	Diff.	1410138-1
	Full Right	16	S.E.	*
		16	Diff.	1410139-1

* Contact Tyco Electronics

25.40 [1.00] Pitch Connector

Type	Style	No. of Cols.	Signal Pattern	Part Number
(Backplane) Receptacle	Center	16	N/A	1410127-1
	Stand Alone	16	N/A	1410131-1
	Half Left	8	N/A	*
	Half Right	8	N/A	*
	Full Left	16	N/A	1410129-1
	Full Right	16	N/A	1410128-1
	Center	16	S.E.	*
(Daughtercard) Plug	Center	16	Diff.	1410123-1
		16	S.E.	*
	Stand Alone	16	Diff.	1410132-1
		16	S.E.	*
	Half Left	8	S.E.	*
		8	Diff.	*
	Half Right	8	S.E.	*
		8	Diff.	*
	Full Left	16	S.E.	*
		16	Diff.	1410124-1
	Full Right	16	S.E.	*
		16	Diff.	1410125-1

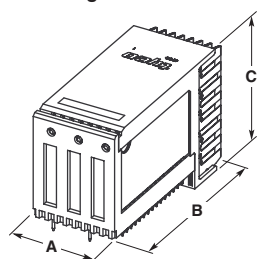
* Contact Tyco Electronics

The drawings below show the nominal dimensions for the MULTIGIG RT 2 connector modules

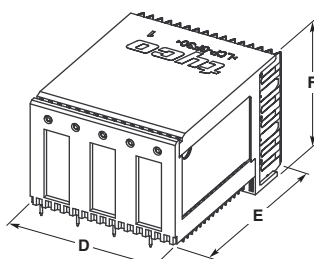
Dim.	20.32 [.800] Connector	25.40 [1.000] Connector
A	16.10 .630	16.10 .630
B	21.60 .850	27.40 1.080
C	18.40 .720	24.20 .950
D	28.70 1.130	28.70 1.130
E	21.60 .850	27.40 1.080
F	18.40 .720	24.20 .950

Dim.	20.32 [.800] Connector	25.40 [1.000] Connector
AA	R = 17.00 .067	R = 17.00 .067
	L = 15.20 .600	L = 15.20 .600
BB	10.50 .410	10.50 .410
CC	18.60 .730	24.40 .960
DD	28.70 1.130	28.70 1.130
EE	10.50 .410	10.50 .410
FF	18.60 .730	24.40 .960

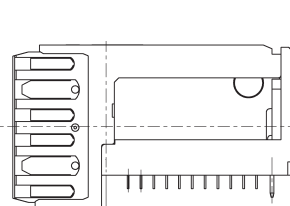
Left/Right End Module



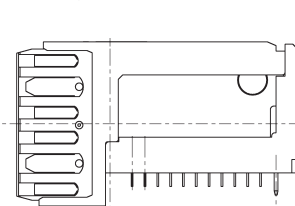
Center Module



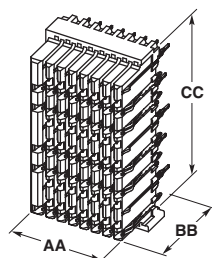
Left Full End Module



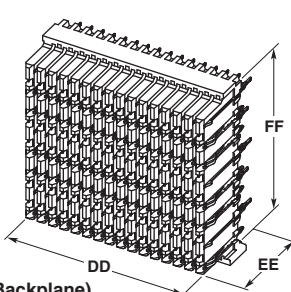
Right Full End Module



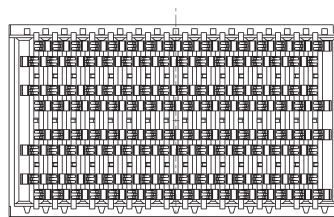
Plug (Daughtercard)



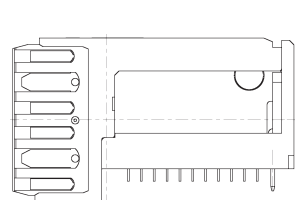
Receptacle (Backplane)



Stand Alone Backplane



Stand Alone Daughtercard



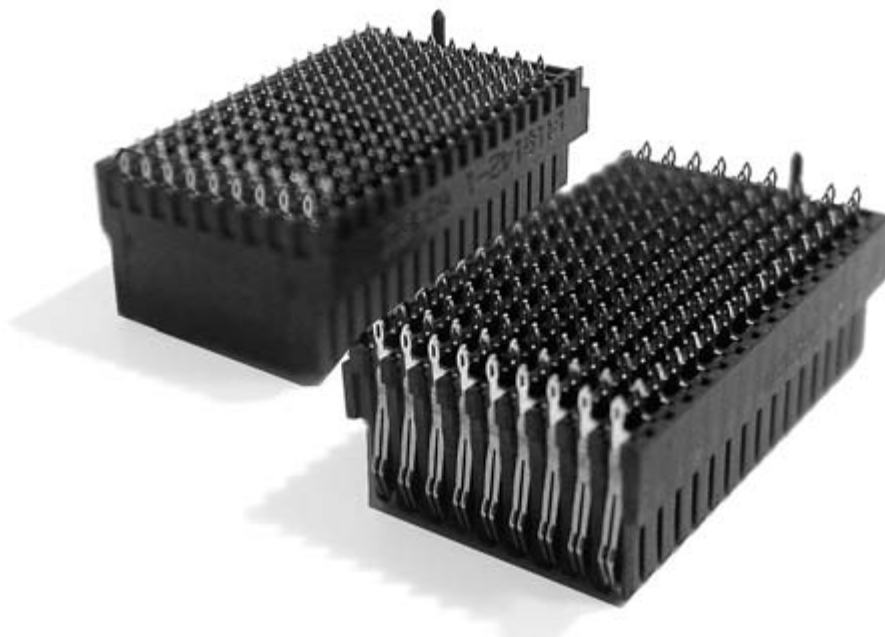
MULTIGIG RT Tier 3 Connector System

Target Applications

- High speed telecommunications equipment
- Midrange and high-end servers
- Networking equipment
- Blindmate design
- High speed custom platforms
- Mass data storage
- Rugged, mission-critical applications

Product Features

- Excellent performance to 10+ Gb/s
- High density: 85 contacts per inch provides 42 contact pairs per inch for differential signaling
- Options include 20.32 [.800] and 25.40 [1.000] pitch card spacing
- Modular options for signal, power, keying and guidance
- Optimized footprints
- Robust design
- Low noise levels
- Supports differential pair widths of 6 mils with 9 mil spacings
- Single-ended, open pin field and power wafers available
- Supports Quad routing
- MULTIGIG RT 3 products are on 2.4mm column spacing



The MULTIGIG RT Tier 3 connector is the latest product release to meet customer requirements for high-density and high-performance two-piece interconnects. In Tyco Electronics and independent lab tests, the MULTIGIG RT Tier 3 connector has performed in excess of 10 Gb/s using standard FR-4 board material and routing techniques, and has been demonstrated to 10 Gb/s.

The MULTIGIG RT Tier 3 connector system provides the flexibility to configure the daughtercard for Differential, Single-ended,

Open Pin Field, or Power within a single connector module. All of these options then mate into a common Backplane Receptacle. The robust connector uses daughtercard plugs with a printed circuit board (PCB) wafer design and backplane receptacles with a completely enclosed dual-beam design. All signal lines use redundant points of contact for high reliability.

The MULTIGIG RT Tier 3 connector is available for both 20.32 [.800] and 25.40 [1.000] pitch card spacing. The totally modular system allows flexibility in choosing signal and power modules

as well as guidance, keying, and electrostatic discharge (ESD) modules to meet the most demanding applications. Signal modules can be customized for specific electrical requirements—such as sequencing—that are critical in high speed applications.

Power modules are available with two- and four-voltage options, each circuit capable of carrying 15 amps. The robust metal guide pin provides eight keying options and a unique ESD contact to discharge static when daughtercards are hot-plugged.

Availability

Fully validated SPICE models: E-mail requests to modeling@tycoelectronics.com

Pro/E models and IGES models: E-mail requests to TycoCAD@tycoelectronics.com

www.tycoelectronics.com

**Mechanical Design
Summary**

MULTIGIG RT Tier 3 Connector System (Continued)

20.30 [.800] Pitch Connector

Type	Style	No. of Cols.	Signal Pattern	Part Number
(Backplane) Receptacle	Center	16	N/A	1410000-1
	Full Right	16	N/A	1410001-1
(Daughtercard) Plug	Center	16	S.E.	*
		16	Diff.	1410005-1
	Full Right	16	S.E.	*
		16	Diff.	1410003-1

* Contact Tyco Electronics.

25.40 [1.00] Pitch Connector

Type	Style	No. of Cols.	Signal Pattern	Part Number
(Backplane) Receptacle	Center	16	N/A	1410006-1
	Full Right	16	N/A	1410018-1
(Daughtercard) Plug	Center	16	S.E.	*
		16	Diff.	1410009-1
	Full Right	16	S.E.	*
		16	Diff.	1410024-1

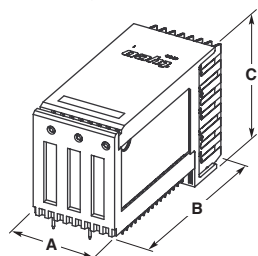
* Contact Tyco Electronics.

The drawings below show the nominal dimensions for the MULTIGIG RT 3 connector modules

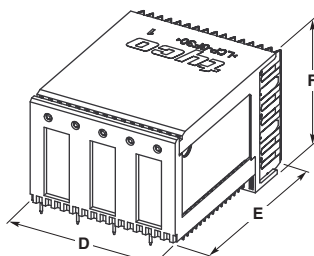
Dim.	20.32 [.800] Connector	25.40 [1.000] Connector
A	16.10 .630	16.10 .630
B	21.60 .850	27.40 1.080
C	18.40 .720	24.20 .950
D	28.70 1.130	28.70 1.130
E	21.60 .850	27.40 1.080
F	18.40 .720	24.20 .950

Dim.	20.32 [.800] Connector	25.40 [1.000] Connector
AA	R = 17.00 .067	R = 17.00 .067
	L = 15.20 .600	L = 15.20 .600
BB	10.50 .410	10.50 .410
CC	18.60 .730	24.40 .960
DD	28.70 1.130	28.70 1.130
EE	10.50 .410	10.50 .410
FF	18.60 .730	24.40 .960

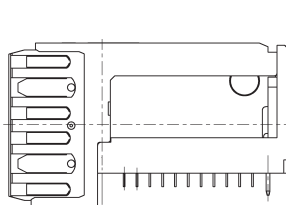
Left/Right End Module



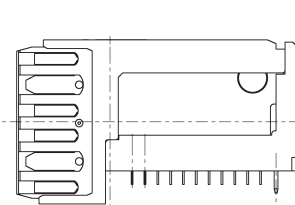
Center Module



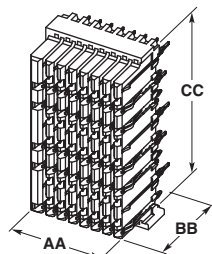
Left Full End Module



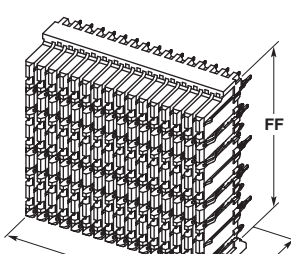
Right Full End Module



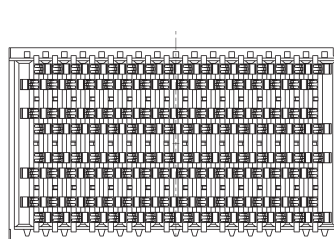
Plug (Daughtercard)



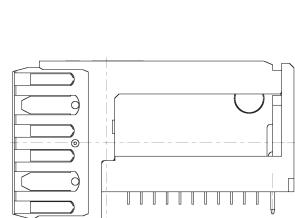
Receptacle (Backplane)



Stand Alone Backplane



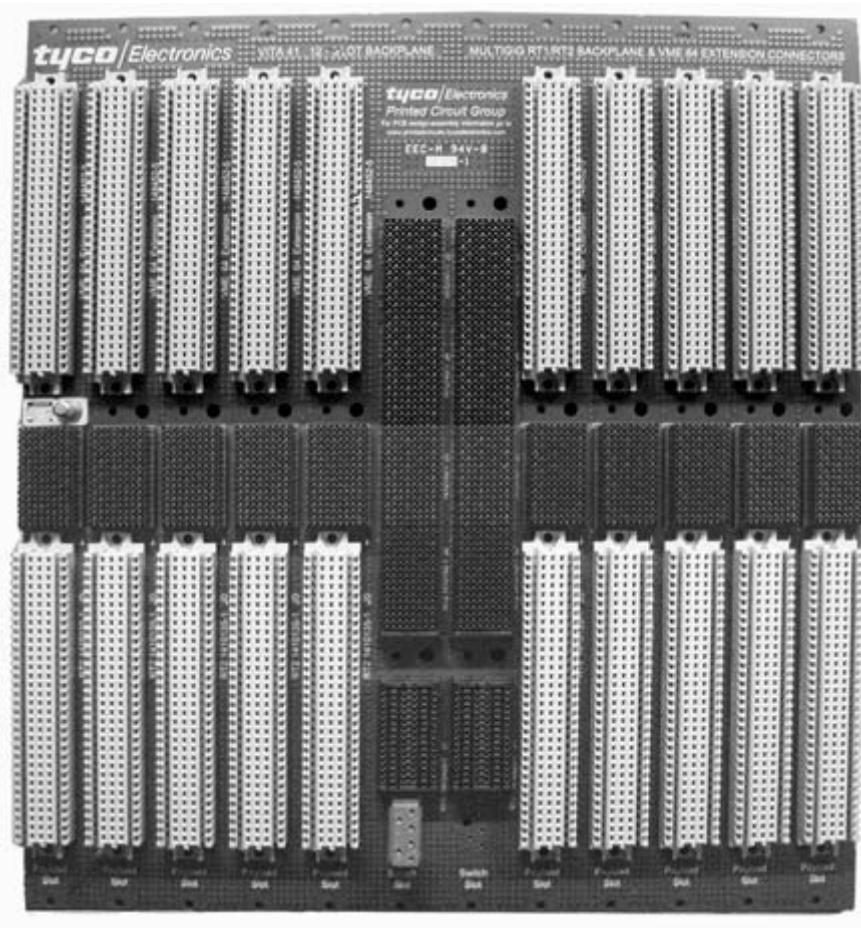
Stand Alone Daughtercard



VITA 41 Connector Selection Grid

**Actual VITA 41,
12 Slot Backplane**

**VITA 41, referred to as VXS,
is the next Generation of
VME Backplanes**



3

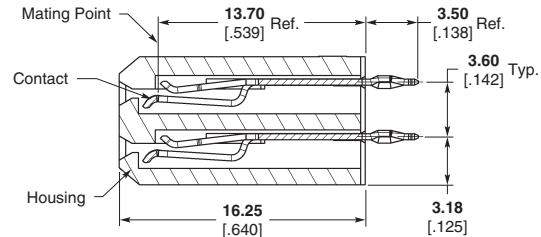
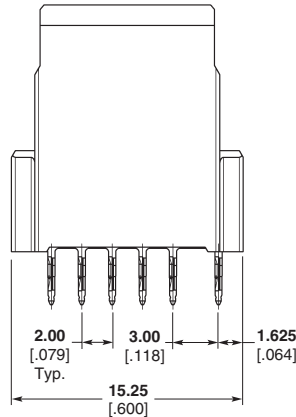
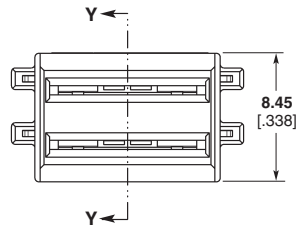
MULTIGIG RT Connector

Connector	Description	Part Number
P0	Tier 2, 7 Row, Center Module, 20.30 [.800] Pitch, Right Angle	1410147-1
P5	Tier 2, Left End Module, 20.30 [.800] Pitch, Right Angle	1410138-1
P4	Tier 2, Center Module, 20.30 [.800] Pitch, Right Angle	1410137-1
P3	Tier 2, Center Module, 20.30 [.800] Pitch, Right Angle	1410137-1
P2	Tier 2, Right End Module, 20.30 [.800] Pitch, Right Angle	1410139-1
P1	Tier 1, Monolithic, 20.30 [.800] Pitch, Right Angle	1410421-1
J0	Tier 2, Center Module, 20.30 [.800] Pitch, Vertical	1410135-1
J5	Tier 2, Left End Module, 20.30 [.800] Pitch, Vertical	1410141-1
J4	Tier 2, Center Module, 20.30 [.800] Pitch, Vertical	1410140-1
J3	Tier 2, Center Module, 20.30 [.800] Pitch, Vertical	1410140-1
J2	Tier 2, Right End Module, 20.30 [.800] Pitch, Vertical	1410142-1
J1	Tier 1, Monolithic Module, 20.30 [.800] Pitch, Vertical	1410420-1

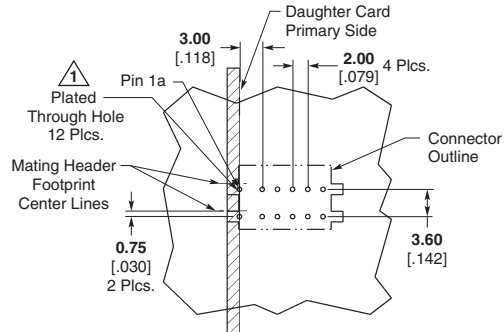
Power Modules and Guide Hardware Reference

Part Number 1410278-1

2-Position Vertical Receptacle



Section Y-Y

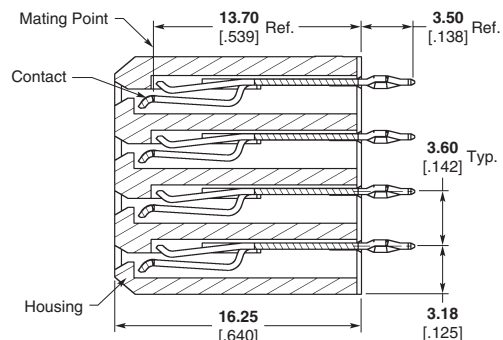
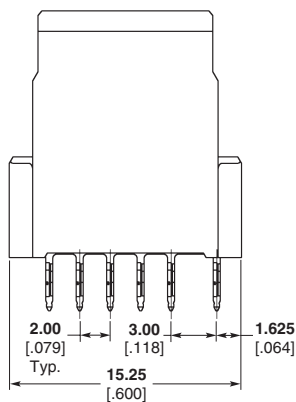
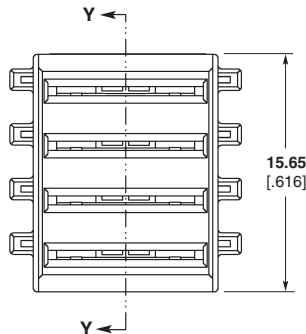


Recommended PCB Hole Layout

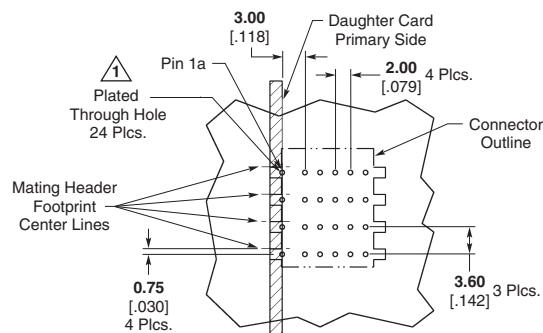
- 1 PCB Hole Dim.
 Drilled Hole = 0.70 ± 0.02 [0.028 $\pm$.001]
 Finished Hole = 0.60 ± 0.05 [0.024 $\pm$.002]
 Cu Thickness = $0.025 - 0.50$ [0.0010 - .020]
 SnPb Thickness = 0.015 [0.0006] Max.

Part Number 1410270-1

4-Position Vertical Receptacle



Section Y-Y



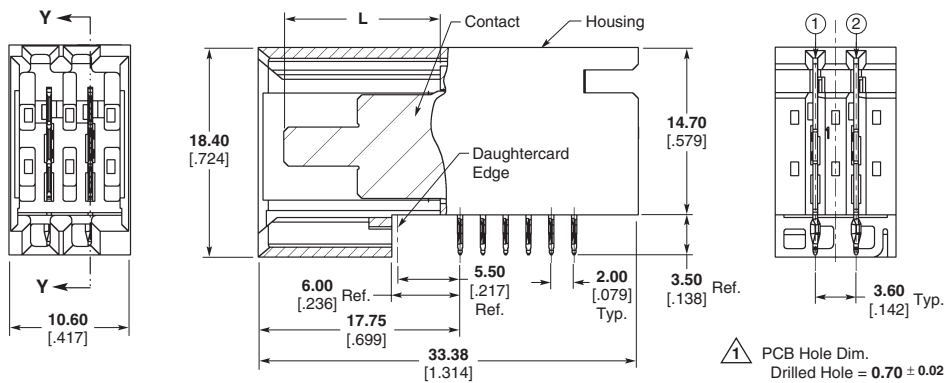
Recommended PCB Hole Layout

- 1 PCB Hole Dim.
 Drilled Hole = 0.70 ± 0.02 [0.028 $\pm$.001]
 Finished Hole = 0.60 ± 0.05 [0.024 $\pm$.002]
 Cu Thickness = $0.025 - 0.50$ [0.0010 - .020]
 SnPb Thickness = 0.015 [0.0006] Max.

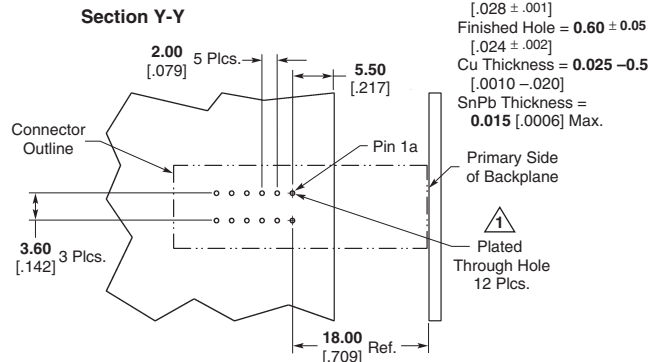
Power Modules and Guide Hardware Reference (Continued)

Part Number 1410279-X

2-Position Right Angle Plug



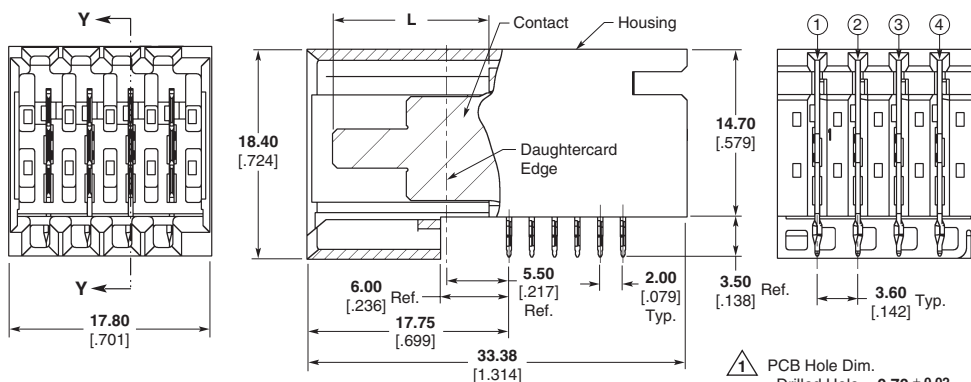
Dim. L		Part Number
Circuit 1	Circuit 2	
13.75 .541	13.75 .541	1410279-1
13.75 .541	12.25 .482	1410279-2
13.75 .541	10.75 .423	1410279-3
10.75 .423	10.75 .423	1410279-4
12.25 .482	10.75 .423	1410279-5
12.25 .482	12.25 .482	1410279-6



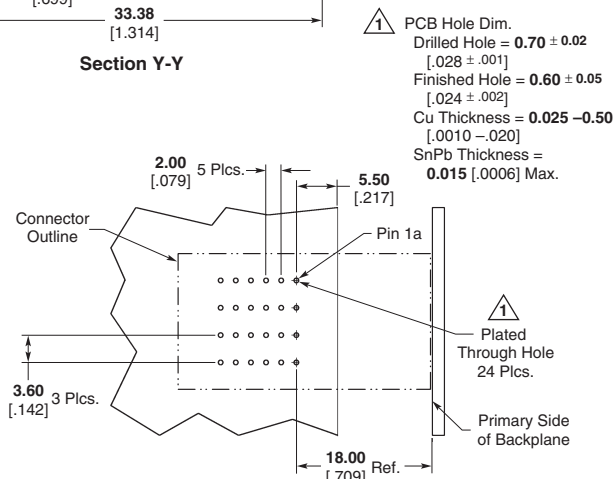
Recommended PCB Hole Layout

Part Number 1410271-X

4-Position Right Angle Plug



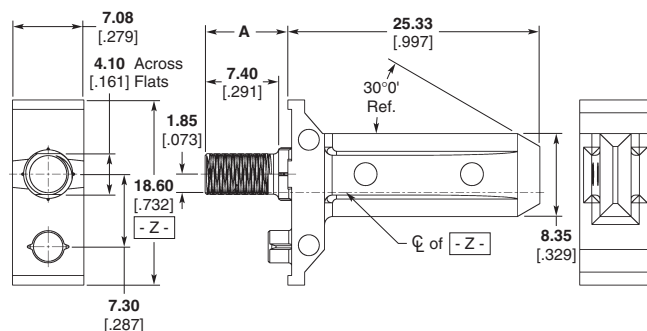
Dim. L				Part Number
Cavity 1	Cavity 2	Cavity 3	Cavity 4	
13.75 .541	13.75 .541	13.75 .541	13.75 .541	1410271-1
12.25 .482	13.75 .541	13.75 .541	12.25 .482	1410271-2
12.25 .482	13.75 .541	13.75 .541	10.75 .423	1410271-3
10.75 .423	13.75 .541	13.75 .541	10.75 .423	1410271-4
12.25 .482	13.75 .541	12.25 .482	10.75 .423	1410271-5
12.25 .482	12.25 .482	12.25 .482	12.25 .482	1410271-6
10.75 .423	12.25 .482	12.25 .482	10.75 .423	1410271-7
10.75 .423	10.75 .423	10.75 .423	10.75 .423	1410271-8
10.75 .423	13.75 .541	12.25 .482	10.75 .423	1410271-9
12.25 .482	10.75 .423	10.75 .541	12.25 .482	1-1410271-0



Recommended PCB Hole Layout

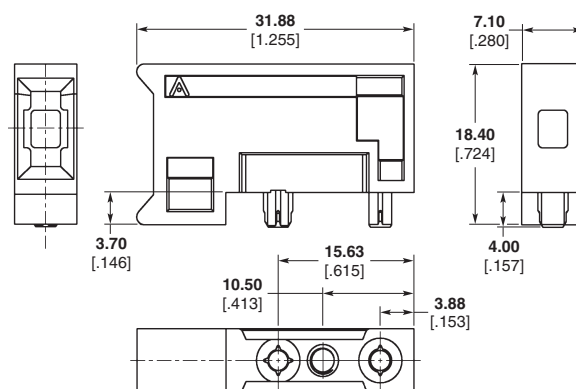
Power Modules and Guide Hardware Reference (Continued)

7.2 mm Wide, No Key



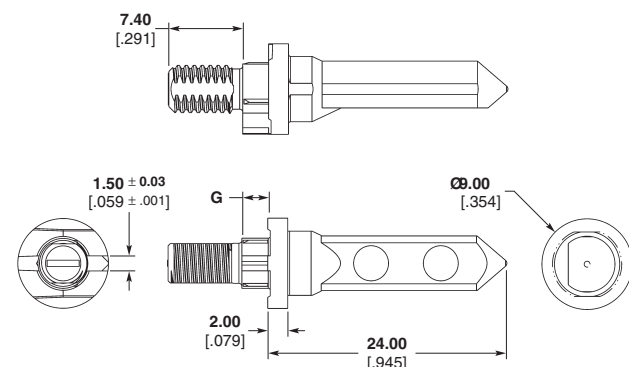
Pin Part Number 1410710-X

Dim. A	Part Number
8.72 .343	1410710-1
10.00 .394	1410710-2
11.60 .457	1410710-3
13.10 .516	1410710-4



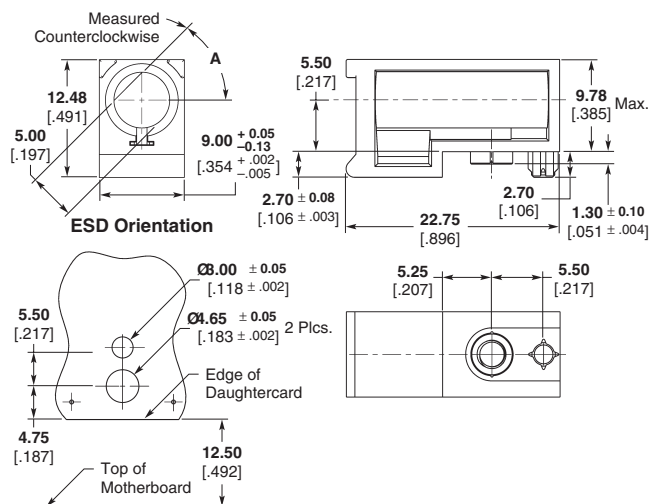
Guide Module Part Number 1410714-2

9.0 mm Wide, with Keying



Pin Part Number 1469491-X

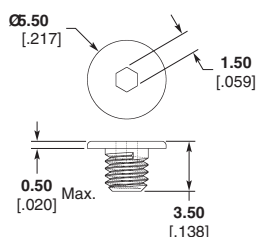
Dim. G	Part Number
2.60 .102	1469491-2
4.20 .165	1469491-3
5.70 .224	1469491-4



Guide Module Part Number 1469492-X

Dim. A	Part Number
0°	1469492-1
45°	1469492-2
90°	1469492-3
270°	1469492-7
315°	1469492-8
No Key	1469492-9

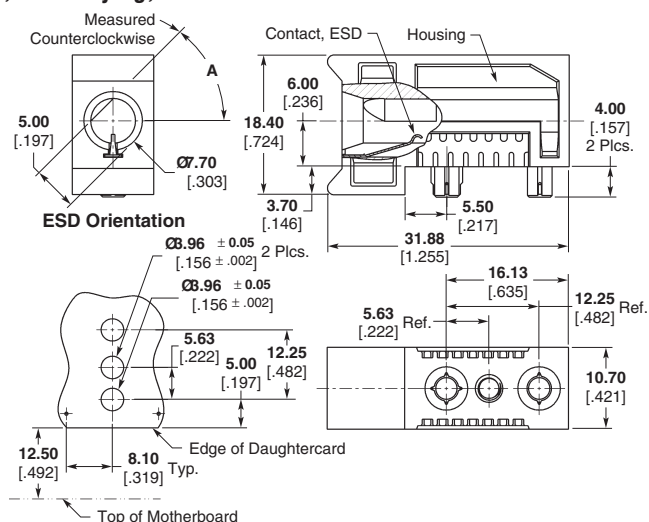
Mounting Screw for 9.0 mm Guide Modules



Part Number 1410946-1

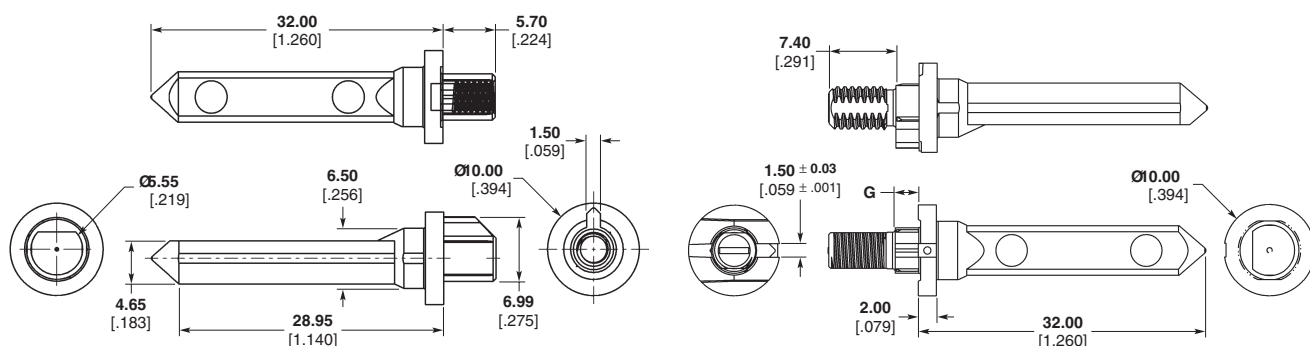
Power Modules and Guide Hardware Reference (Continued)

10.8 mm Wide, Guide Module, with Keying, with ESD Contact



Guide Module Part Number 1410297-X

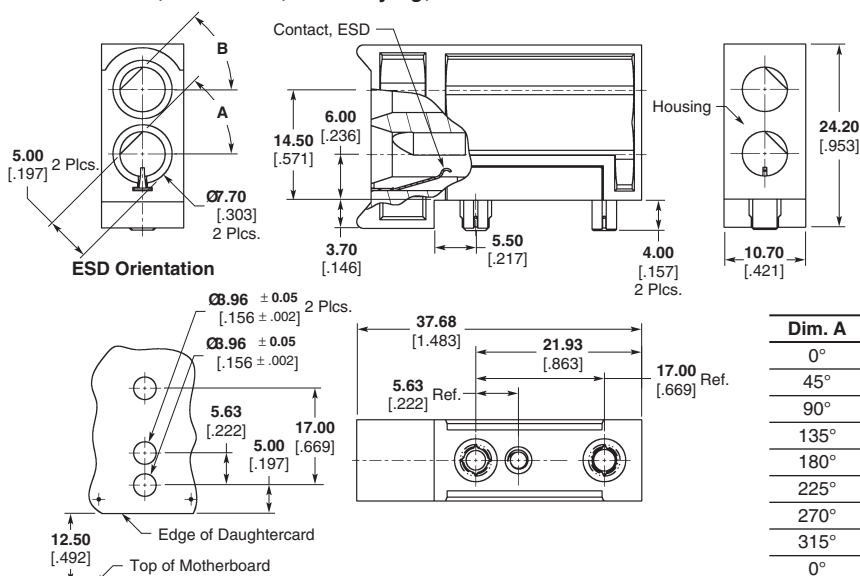
Dim. A	Part Number
0°	1410297-1
45°	1410297-2
90°	1410297-3
135°	1410297-4
180°	1410297-5
225°	1410297-6
270°	1410297-7
315°	1410297-8
No Key	1410297-9



Pin Part Number 1410548-2

Pin Part Number 1410773-X

10.8 mm Wide, Guide Pin, with Keying, with ESD Contact



Guide Module Part Number 1410298

Dim. G	Part Number
2.60 .102	1410773-2
4.20 .165	1410773-3
5.70 .224	1410773-4

Dim. A	Dim. B	Part Number
0°	0°	1410298-1
45°	0°	1410298-2
90°	0°	1410298-3
135°	0°	1410298-4
180°	0°	1410298-5
225°	0°	1410298-6
270°	0°	1410298-7
315°	0°	1410298-8
0°	45°	1410298-9
45°	45°	1-1410298-0